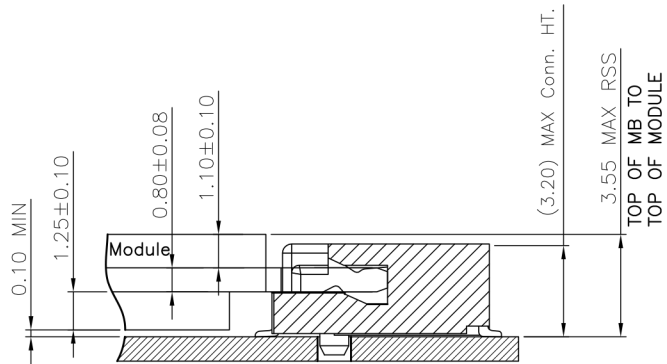
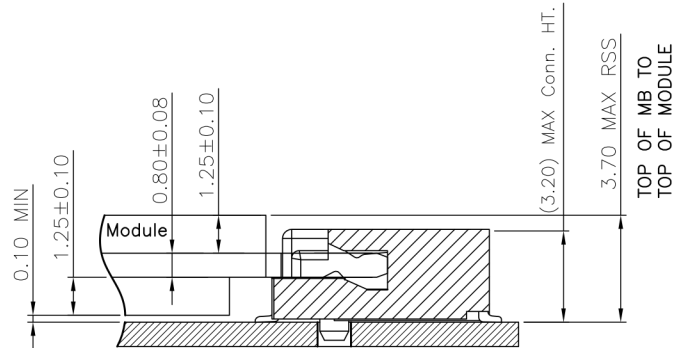


F
E
D
C
B
A

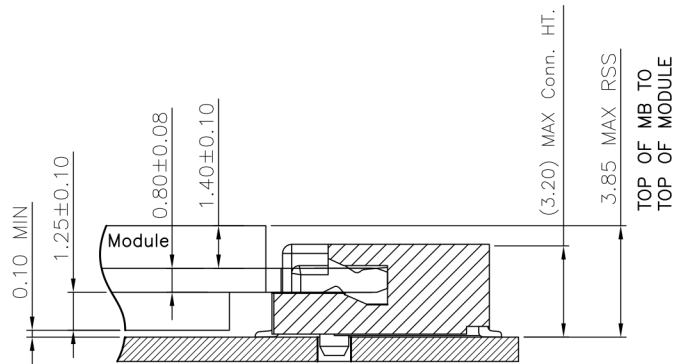
Assembly stack height schematic diagram



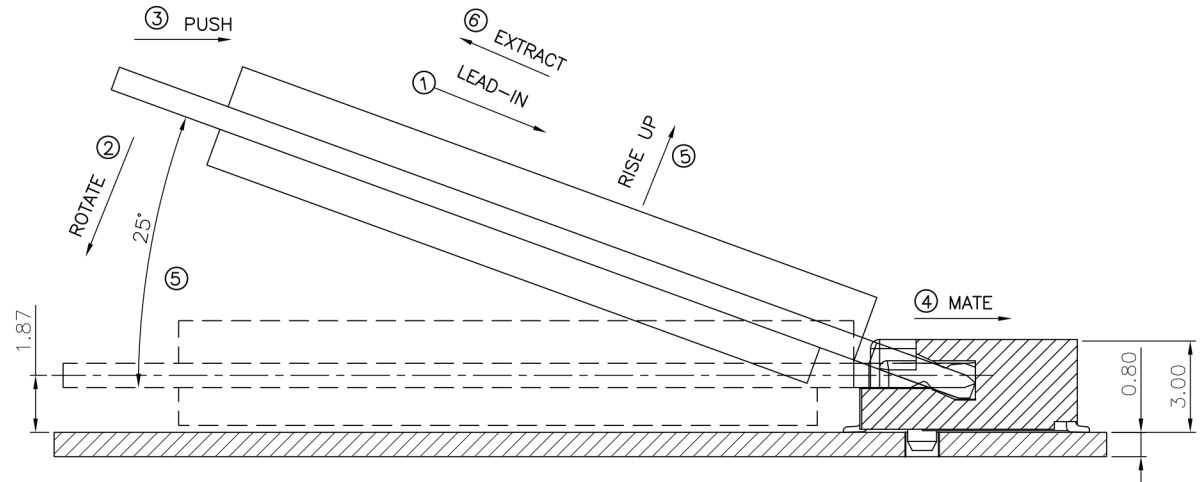
Stack-up Top Mount Double Sided Module
for 1.20 max top-side component height



Stack-up Top Mount Double Sided Module
for 1.35 max top-side component height



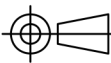
Stack-up Top Mount Double Sided Module
for 1.5 max top-side component height



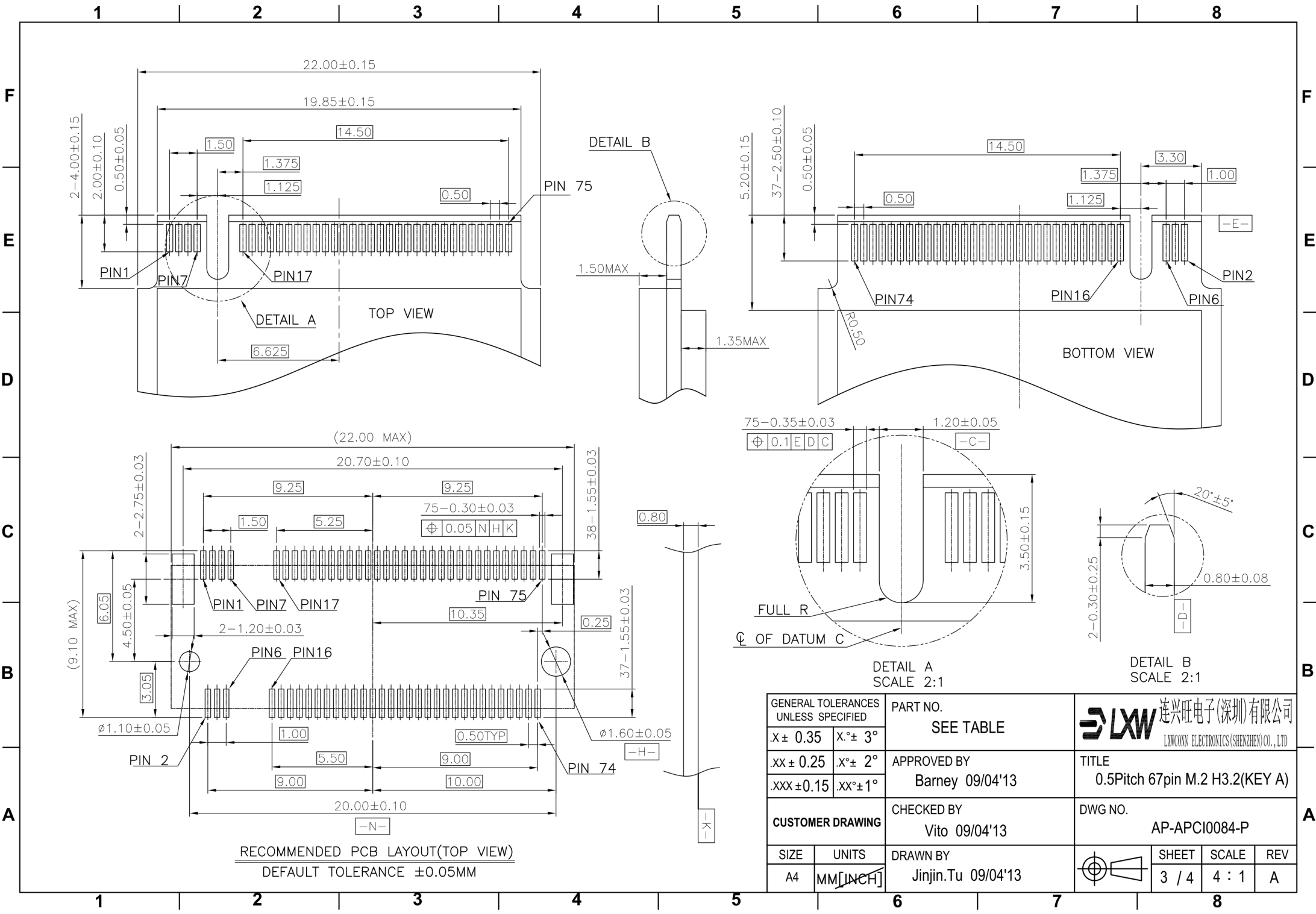
HOW TO MATE AND EXTRACT
=====

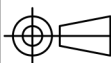
MATE: ① —————> ④
EXTRACT: ⑤ —————> ⑥

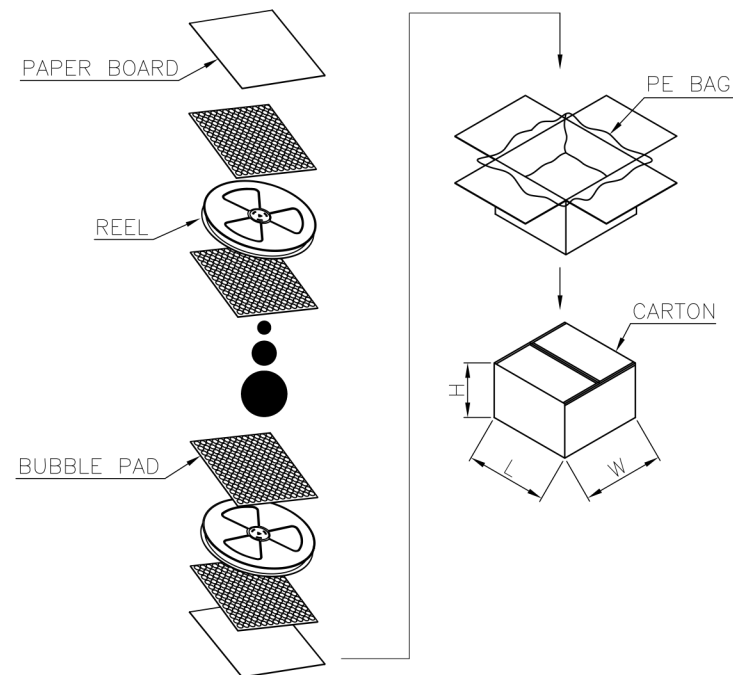
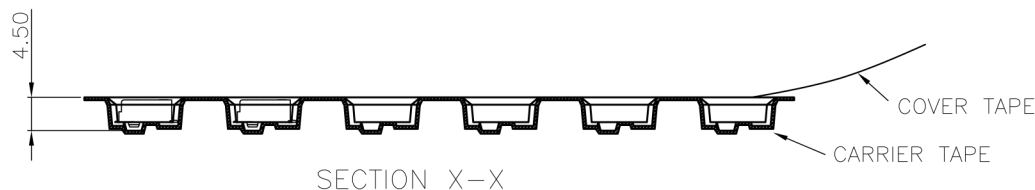
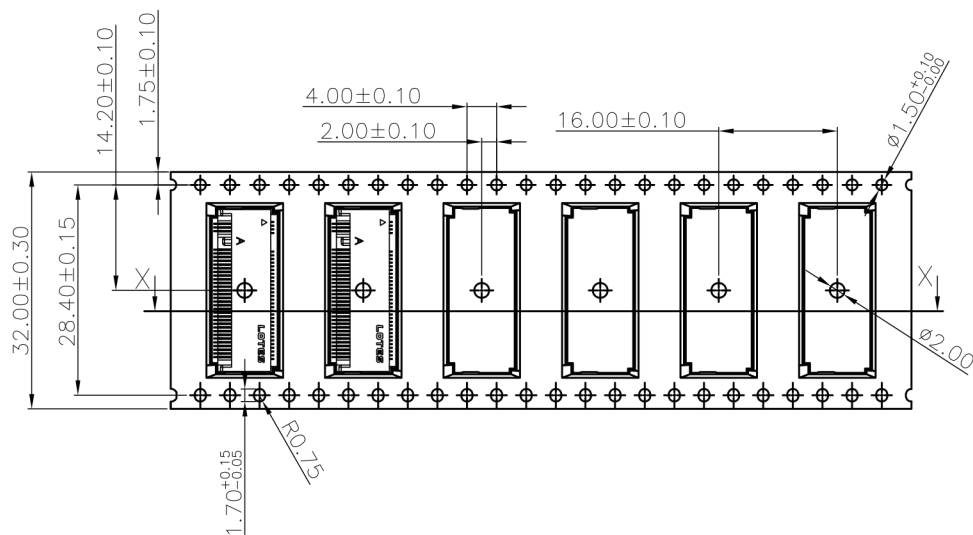
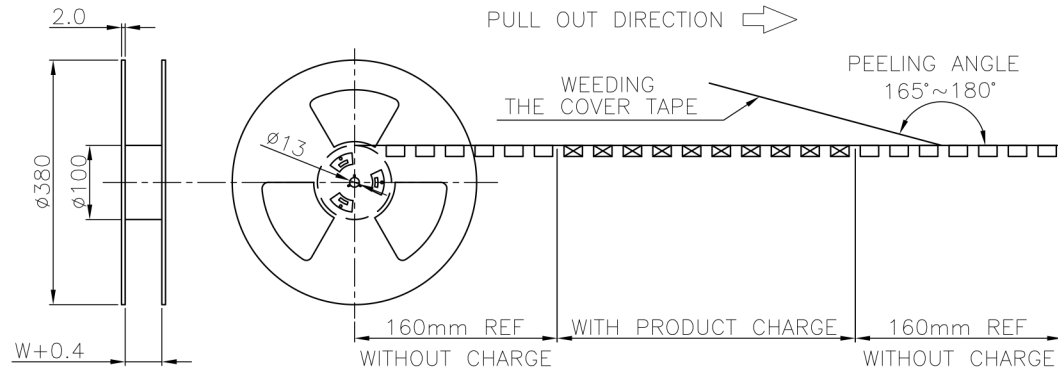
NOTE:Mating force will generate from step 3 to step 4.

GENERAL TOLERANCES UNLESS SPECIFIED		PART NO. SEE TABLE	 连兴旺电子(深圳)有限公司 LXWOXON ELECTRONICS(SHENZHEN) CO., LTD			
.X ± 0.35	X.° ± 3°					
.XX ± 0.25	X.° ± 2°	APPROVED BY Barney 09/04'13	TITLE 0.5Pitch 67pin M.2 H3.2(KEY A)			
.XXX ± 0.15	.XX ± 1°					
CUSTOMER DRAWING		CHECKED BY Vito 09/04'13	DWG NO. AP-APCI0084-P			
SIZE	UNITS					
A4	MM[INCH]	DRAWN BY Jinjin.Tu 09/04'13		SHEET 2 / 4	SCALE 4 : 1	REV A

F
E
D
C
B
A



GENERAL TOLERANCES UNLESS SPECIFIED		PART NO. SEE TABLE		 连兴旺电子(深圳)有限公司 LXWONN ELECTRONICS(SHENZHEN) CO., LTD			
.X ± 0.35	X.°± 3°			TITLE 0.5Pitch 67pin M.2 H3.2(KEY A)			
.XX ± 0.25	.X.°± 2°						
.XXX ±0.15	.XX.°±1°	APPROVED BY Barney 09/04'13					
CUSTOMER DRAWING		CHECKED BY Vito 09/04'13		DWG NO. AP-APCI0084-P			
SIZE A4	UNITS MM[INCH]	DRAWN BY Jinjin.Tu 09/04'13			SHEET 3 / 4	SCALE 4 : 1	REV A



GENERAL TOLERANCES
UNLESS SPECIFIED

.X ± 0.35	X. $^{\circ} \pm 3^{\circ}$
.XX ± 0.25	X. $^{\circ} \pm 2^{\circ}$
.XXX ± 0.15	.XX $\pm 1^{\circ}$

CUSTOMER DRAWING

SIZE	UNITS
A4	MM[INCH]

PART NO.
SEE TABLE

APPROVED BY
Barney 09/04'13

CHECKED BY
Vito 09/04'13

DRAWN BY
Jinjin.Tu 09/04'13

1200	9600
PCS/REEL	PCS/CARTON

LXW 连兴旺电子(深圳)有限公司
LXWONN ELECTRONICS(SHENZHEN) CO., LTD

TITLE
0.5Pitch 67pin M.2 H3.2(KEY A)

DWG NO.
AP-APCI0084-P

SHEET	SCALE	REV
4 / 4	1 : 1	A